

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	368	(takamura near3 Yukihiro).in. or (Kajino near3 Kazuki).in. or (Masuichi near3 Mikio).in. or (Kawamura near3 Takashi).in.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2005/05/19 14:22
L2	69	1 and (rotat\$3 or spin or alternat\$4)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2005/05/19 14:26
S1	3	(""6255228") or ("6494221") or ("5879576").PN.	USPAT; USOCR	OR	OFF	2004/12/15 11:48
S2	1	("6683007").PN.	USPAT; USOCR	OR	OFF	2004/12/02 15:07
S3	13	("5032217"   "5204687"   "5520205"   "5546094"   "5779816"   "5801662"   "5861066"   "6063232"   "6155275"   "6202658"   "6260562"   "6299697"   "6494221").PN.	USPAT	OR	ON	2004/12/02 15:25
S4	5	(("6683007") or ("6260562") or ("5601645") or ("6516815") or ("6558478")).PN.	USPAT; USOCR	OR	OFF	2004/12/02 16:09
S5	205	(156/345.21,345.55).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2004/12/02 16:25
S6	2859	(134/94.1,99.1,157,137,198,199). CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2004/12/02 16:26
S7	561	((134/94.1,99.1,157,137,198, 199).CCLS.) and (wafer or substrate or (work adj piece) or workpiece)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/12/02 16:28
S8	561	(((134/94.1,99.1,157,137,198, 199).CCLS.) and (wafer or substrate or (work adj piece) or workpiece)) and (ad<="20000314" or rlad<="20000314")	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/12/02 16:36

S9	375	((134/94.1,99.1,157,137,198, 199).CCLS.) and (wafer or substrate or (work adj piece) or workpiece)) and (@ad<="20000314" or @rlad<="20000314")	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/12/02 16:53
S10	66	(((134/94.1,99.1,157,137,198, 199).CCLS.) and (wafer or substrate or (work adj piece) or workpiece)) and (@ad<="20000314" or @rlad<="20000314")) and nozzle	EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/12/02 16:53
S11	6	("6255228") or ("5993547") or ("6516815") or ("4668334") or ("5861066") or ("6494221").PN.	USPAT; USOCR	OR	OFF	2004/12/14 20:18
S12	3	((("6255228") or ("5993547") or ("6516815") or ("4668334") or ("5861066") or ("6494221")).PN.) and (mm or millimeter)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/12/14 20:19
S13	5	"6494221"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/12/15 11:48
S14	2	"6494221".pn.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/12/15 11:54
S15	2	("5879576").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2004/12/15 13:50
S16	4133	(118/728,500).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2004/12/15 13:52
S17	4	((118/728,500).CCLS.) and ((first adj3 pin) same (second adj3 pin) same rotat\$3)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/12/15 14:00
S18	4757	((first adj3 pin) same (second adj3 pin) same rotat\$3)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/12/15 15:53

S19	428	( ((first adj3 pin) same (second adj3 pin) same rotat\$3)) and (wafer or substrate or workpiece or (work adj piece))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/12/15 15:54
S20	231	(( ((first adj3 pin) same (second adj3 pin) same rotat\$3)) and (wafer or substrate or workpiece or (work adj piece))) not pivot	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/12/15 14:10
S21	915	( ((first adj3 pin) same (second adj3 pin) same rotat\$3)) same (susceptor or holder or support)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/12/15 15:54
S22	108	(( ((first adj3 pin) same (second adj3 pin) same rotat\$3)) same (susceptor or holder or support)) and (wafer or substrate or workpiece or (work adj piece))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/12/15 16:02
S23	59	((( ((first adj3 pin) same (second adj3 pin) same rotat\$3)) same (susceptor or holder or support)) and (wafer or substrate or workpiece or (work adj piece))) not ((( ((first adj3 pin) same (second adj3 pin) same rotat\$3)) and (wafer or substrate or workpiece or (work adj piece))) not pivot)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/12/15 16:03
S24	9	("6202858") or ("5520205") or ("5779816") or ("6155275") or ("6063232") or ("6299697") or ("6260562") or ("6494221") or ("5861066")).PN.	USPAT; USOCR	OR	OFF	2005/01/13 17:51
S25	1	("6202658").PN.	USPAT; USOCR	OR	OFF	2005/01/13 17:53
S26	2	JP-08078378-\$ DID.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/01/13 17:55

S27	15	JP-62264626-\$ DID. OR JP-02197126-\$ DID. OR JP-01259536-\$ DID. OR JP-08323303-\$ DID. OR JP-09275087-\$ DID. OR JP-05226808-\$ DID. OR JP-63022665-\$ DID. OR JP-10242114-\$ DID. OR JP-09260331-\$ DID. OR JP-04340226-\$ DID. OR JP-09293715-\$ DID. OR JP-10079334-\$ DID. OR JP-02309638-\$ DID. OR JP-08236435-\$ DID. OR JP-09186519-\$ DID.	JPO	OR	ON	2005/01/13 18:16
S28	2	EP-368334-\$ DID.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/01/13 18:18
S29	3	EP-924754-\$ DID. OR EP-814536-\$ DID. OR EP-516490-\$ DID. OR EP-736925-\$ DID.	EPO	OR	ON	2005/01/13 18:20
S30	8	EP-924754-\$ DID. OR EP-814536-\$ DID. OR EP-516490-\$ DID. OR EP-736925-\$ DID.	EPO; DERWENT	OR	ON	2005/01/13 18:25
S31	2	WO-9946064-\$ DID.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/01/13 18:27
S32	2	WO-9922419-\$ DID.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/01/13 18:27
S33	0	TW-333165-\$ DID.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/01/13 18:28
S34	10	"333165"	DERWENT	OR	ON	2005/01/13 18:39
S35	2	("5879576").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/01/13 18:39

S36	0	("(S50RS70RS170RS190RS210RS22)AND@PD>=20041215AND(@AD<=20000314OR@RLAD<=2000314)".PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/05/11 16:49
S37	247	(156/345.21,345.55).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/05/11 16:49
S38	605	((134/94.1,99.1,157,137,198,199).CCLS.) and (wafer or substrate or (work adj piece) or workpiece)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/11 16:49
S39	4	((118/728,500).CCLS.) and ((first adj3 pin) same (second adj3 pin) same rotat\$3)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/11 16:49
S40	444	( ((first adj3 pin) same (second adj3 pin) same rotat\$3)) and (wafer or substrate or workpiece or (work adj piece))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/11 16:49
S41	957	( ((first adj3 pin) same (second adj3 pin) same rotat\$3)) same (susceptor or holder or support)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/11 16:49
S42	112	(( ((first adj3 pin) same (second adj3 pin) same rotat\$3)) same (susceptor or holder or support)) and (wafer or substrate or workpiece or (work adj piece))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/11 17:06
S43	15	(S37 OR S38 OR S39 OR S40 OR S41 OR S42)AND @PD>="20041215" AND (@AD<="20000314" OR @RLAD<="20000314")	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2005/05/13 12:08
S44	40	(( ((first adj3 pin) same (second adj3 pin) same alternat\$6)) same (susceptor or holder or support)) and (wafer or substrate or workpiece or (work adj piece))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/11 17:38

S45	11322	(pin same (alternat\$6 or rotat\$3) same (susceptor or holder or support)) and (wafer or substrate or workpiece or (work adj piece))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/11 17:41
S46	4873	(pin same (alternat\$6 or rotat\$3) same (susceptor or holder or support)) same (wafer or substrate or workpiece or (work adj piece))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/11 17:42
S47	323	(pin same (alternat\$6 or rotat\$3) same (susceptor or holder or support)) same ((edge or (end face)) adj (wafer or substrate or workpiece or (work adj piece)))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/11 17:46
S48	311	S47 not (S37 OR S38 OR S39 OR S40 OR S41 OR S42)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2005/05/11 17:47
S49	215	S48 AND (@AD<="20000314" OR @RLAD<="20000314")	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2005/05/11 17:48
S50	207	(Shinya near3 Yamasaki).in. or (Hidemitsu near3 Aoki).in.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2005/05/12 17:54
S51	2	(1999JP-0334466).ap.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2005/05/13 10:44
S52	247	(156/345.21,345.55).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/05/13 12:08
S53	605	((134/94.1,99.1,157,137,198, 199).CCLS.) and (wafer or substrate or (work adj piece) or workpiece)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/13 12:08

S54	4	((118/728,500).CCLS.) and ((first adj3 pin) same (second adj3 pin) same rotat\$3)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/13 12:08
S55	444	((first adj3 pin) same (second adj3 pin) same rotat\$3)) and (wafer or substrate or workpiece or (work adj piece))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/13 12:08
S56	957	((first adj3 pin) same (second adj3 pin) same rotat\$3)) same (susceptor or holder or support)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/13 12:08
S57	112	((first adj3 pin) same (second adj3 pin) same rotat\$3)) same (susceptor or holder or support)) and (wafer or substrate or workpiece or (work adj piece))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/13 12:08
S58	15	(S52 OR S53 OR S54 OR S55 OR S56 OR S57) AND @PD>="20041215" AND (@AD<="20000314" OR @RLAD<="20000314")	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2005/05/13 12:08